PIP3221-DC

Dual channel high-side TOPFET™

Rev. 01 — 20 February 2004

Product data

1. Product profile

1.1 Description

Monolithic temperature and overload protected dual high-side power switch based on TOPFET™ Trench technology in a 7-pin surface mount plastic package.

1.2 Features

- Very low quiescent current
- Power TrenchMOS™
- Overtemperature protection
- Over and undervoltage protection
- Reverse battery protection
- Low charge pump noise
- Loss of ground protection
- Negative load clamping

- CMOS logic compatibility
- Current limitation
- Soft latched overload protection
- ESD protection for all pins
- Diagnostic status indication
- Off-state open load detection
- Load dump protection
- Internal ground resistor.

1.3 Applications

- 12 and 24 V grounded loads
- Inductive loads

- High inrush current loads
- Replacement for relays and fuses.

1.4 Quick reference data

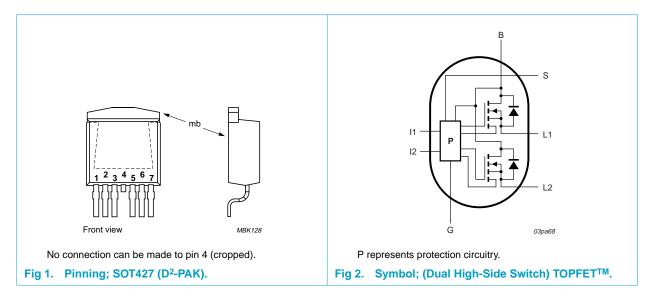
Table 1: Quick reference data

Symbol	Parameter	Min	Max	Units
R _{BLon}	battery-load on-state resistance	-	90	m $Ω$
IL	load current	-	4	Α
$I_{L(nom)}$	nominal load current (ISO)	3.6	-	Α
I _{L(lim)}	self-limiting load current	8	16	Α
V _{BG(oper)}	battery-ground operating voltage	5.5	35	V





2. Pinning information



2.1 Pin description

Table 2: Pin description

Symbol	Pin	I/O		Description
L1	1	0		load 1
G	2	-		circuit common ground
I1	3	I		input 1
В	4	-	[1] [2]	battery
S	5	0		status
12	6	I		input 2
L2	7	0		load 2
-	mb	-	[2]	mounting base

^[1] Pin 4 is cropped and cannot be connected to the PCB by surface mounting.

3. Ordering information

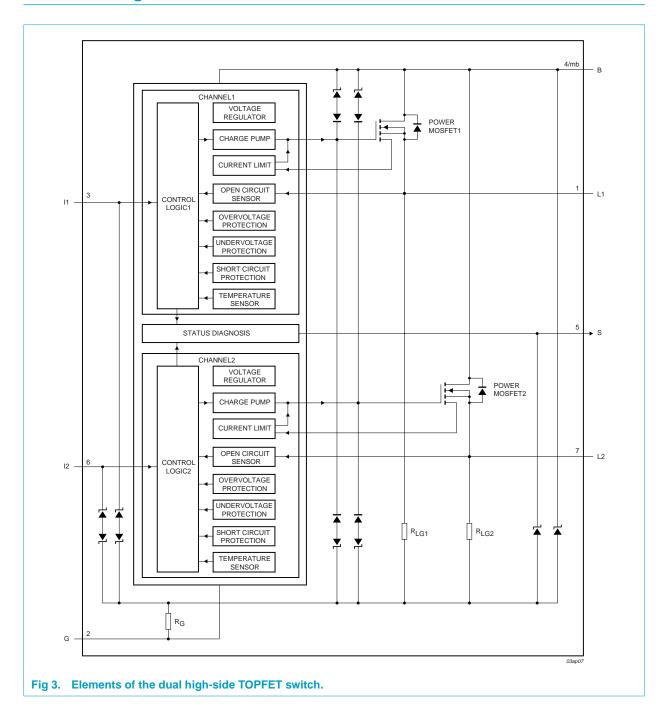
Table 3: Ordering information

Type number	Package	ackage							
	Name	Description	Version						
PIP3221-DC	D ² -PAK	Plastic single-ended surface mounted package (Philips version of D²-PAK); 7 leads (one lead cropped)	SOT427						

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^[2] The battery is connected to the mounting base.

4. Block diagram



5. Functional description

A diagnostic status ensures faster fault detection.

Active current limit is combined with a soft latched short circuit protection feature in order to protect the device in the event of a short circuit.

Thermal shutdown for high temperature conditions has an automatic restart at a lower temperature so providing protection against excessive power dissipation.

Active clamping protects the device against low energy spikes.

Undervoltage lockout means the device shuts down for low battery voltages, thus avoiding faulty operation.

Overvoltage shutdown in the on-state protects a load such as a lamp filament from potentially destructive voltage spikes.

Table 4: Truth table

Abbreviations: L = logic LOW; H = logic HIGH; X = don't care; 0 = condition not present; 1 = condition present; UV = undervoltage; UV = under

Inp	out	Sup	ply		Load 1			Load 2	2	Load	output	Status	Operating mode
1	2	UV	OV	ОС	sc	ОТ	ОС	sc	ОТ	1	2		
L	L	0	Χ	0	Χ	Χ	0	Χ	Χ	OFF	OFF	Н	both off & normal
L	L	0	Χ	1	Χ	Х	Χ	Χ	Х	OFF	OFF	L	both off, one/both OC or shorted to V _S or battery; Figure 10
L	Н	0	X	1	X	Х	0	0	0	OFF	ON	L	one off & OC, with other on & normal
Н	L	0	0	0	0	0	0	0	0	ON	OFF	Н	one on & normal, with other off & normal
Н	Н	0	0	0	0	0	0	0	0	ON	ON	Н	both on & normal
Н	Χ	1	0	Χ	Χ	Χ	0	Χ	Χ	OFF	OFF	Н	supply undervoltage lockout
Н	Х	0	1	X	0	0	Χ	0	0	OFF	OFF	Н	supply overvoltage shutdown
Н	Χ	0	0	0	1	Χ	Χ	Χ	Χ	OFF	Χ	L	one SC shutdown
Н	L	0	0	0	1	Х	0	0	Х	OFF	OFF	L	one SC shutdown, with other off & normal
Н	Н	0	0	0	1	Х	0	0	0	OFF	ON	L	one SC shutdown, with other on & normal
Н	Χ	0	0	0	0	1	Χ	Χ	Χ	OFF	X	L	one OT shutdown
Н	L	0	0	0	0	1	0	0	Х	OFF	OFF	L	one OT shutdown, with other off & normal
Н	Н	0	0	0	0	1	0	0	0	OFF	ON	L	one OT shutdown, with other on & normal

^[1] The status will continue to indicate OT (even if the input goes LOW) until the device cools below the reset threshold temperature. See "Overtemperature protection" characteristics in Table 7 "Static characteristics".

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Limiting values

Limiting values Table 5:

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{BG}	battery-ground supply voltage		[1]	-	45	V
IL	load current	T _{mb} ≤ 130 °C		-	4	Α
P _{tot}	total power dissipation	T _{mb} ≤ 25 °C		-	44.6	W
T _{stg}	storage temperature			-55	+175	°C
Tj	junction temperature			-40	+150	°C
T _{mb}	mounting base temperature	during soldering (≤ 10 s)		-	260	°C
Reverse b	attery voltage					
V_{BGR}	reverse battery-ground supply voltage	$R_I \ge 3.3 \text{ k}\Omega; R_{SS} \ge 3.3 \text{ k}\Omega; \text{ Figure 10}$	[2]	-	16	V
V_{BGRR}	repetitive reverse battery-ground supply voltage			-	32	V
Input curre	ent					
II	input current			-5	+5	mA
I _{IRM}	repetitive peak input current	$\delta \le 0.1$; $t_p = 300 \ \mu s$		-50	+50	mΑ
Status cur	rent					
Is	status current			-5	+5	mA
I _{SRM}	repetitive peak status current	$\delta \le 0.1$; $t_p = 300 \ \mu s$		-50	+50	mA
Inductive	load clamping					
E _{BL(CL)S}	non-repetitive battery-load clamping energy	T_j = 150 °C prior to turn-off; V_{BG} = 13 V; I_L = 5 A; (one channel) Figure 13		-	60	mJ
Electrosta	tic discharge voltage					
V _{esd}	electrostatic discharge voltage	Human Body Model 1; C = 100 pF; R = 1.5 k Ω		-	2	kV

^[1] The device will not be harmed by exposure to the maximum supply voltage, but normal operation is not possible because of overvoltage shutdown - see Table 7 "Static characteristics" for the operating range.

Thermal characteristics

Table 6: **Thermal characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	per channel	-	4	5.6	K/W
		both channels	-	2	2.8	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	mounted on printed circuit board; minimum footprint	-	50	-	K/W

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^[2] Reverse battery voltage is only allowed with external resistors to limit the input and status currents to a safe value. The connected load must limit the reverse load current. The internal ground resistor limits the reverse battery ground current. See Figure 10 "Typical dynamic response circuit diagram including reverse supply protection and open load detection."

8. Static characteristics

Table 7: Static characteristics

Limits are valid for $-40 \,^{\circ}\text{C} \le T_{mb} \le +150 \,^{\circ}\text{C}$ and typical values for $T_{mb} = 25 \,^{\circ}\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Clamping	voltage						
$V_{BG(CL)}$	battery-ground clamping voltage	$I_G = 1 \text{ mA}$		45	55	65	V
$V_{BL(CL)}$	battery-load clamping voltage	$I_L = I_G = 1 \text{ mA}$		50	55	65	V
V _{LG(CL)}	load-ground clamping voltage	I _L = 10 mA; Figure 13	[1]	-18	-23	-28	V
		$I_L = 4 \text{ A}; t_p = 300 \ \mu\text{s}$		-20	-25	-30	V
Supply vo	Itage						
$V_{BG(oper)}$	battery-ground operating voltage			5.5	-	35	V
Current [2]							
I_B	battery quiescent current	$V_{LG} = V_{IG} = 0 V$; Figure 9	[3]				
		T _{mb} = 150 °C		-	-	20	μΑ
		T _{mb} = 25 °C		-	0.1	1	μΑ
I _{L(off)}	off-state load current	$V_{BL} = V_{BG}$; per channel					
		T _{mb} = 150 °C		-	-	10	μΑ
		T _{mb} = 25 °C		-	0.1	1	μΑ
I _{G(on)}	operating current	one channel on; Figure 5		-	2	3	mΑ
		both channels on		-	4	6	mΑ
I _{L(nom)}	nominal load current (ISO)	V_{BL} = 0.5 V; T_{mb} = 85 °C	[4]	3.6	-	-	Α
Resistanc	e						
R _{BLon}	battery-load on-state resistance	$9 \le V_{BG} \le 35 \text{ V}; I_L = 4 \text{ A}; Figure$	e 4 ^[5]				
		T _{mb} = 25 °C		-	73	90	$m\Omega$
		T _{mb} = 150 °C		-	146	180	$m\Omega$
		$V_{BG} = 5.5 \text{ V}; I_L = 4 \text{ A}$					
		T _{mb} = 25 °C		-	76	120	$m\Omega$
		T _{mb} = 150 °C		-	150	240	$m\Omega$
R_{G}	ground resistor	$I_G = -200 \text{ mA}; t_p = 300 \mu\text{s}$	[6]	40	75	100	Ω
Input [7]							
I _I	input current	V _{IG} = 5 V		20	60	160	μΑ
V _{IG(CL)}	input-ground clamping voltage	I _I = 200 μA		5.5	7	8.5	V
V _{IG(on)}	input-ground turn-on voltage	Figure 8		-	2.1	3	V
$V_{IG(off)}$	input-ground turn-off voltage			1.2	1.8	-	V
V _{IG(on)(hys)}	input-ground turn-on hysteresis			0.15	0.3	0.5	V
I _{I(on)}	input turn-on current	$V_{IG} = 3 V$		-	-	100	μΑ
I _{I(off)}	input turn-off current	V _{IG} = 1.2 V		12	-	-	μΑ
Open curr	ent detection [8][9]						
V _{LG(oc)}	load-ground open circuit voltage	$V_{BG} \ge 9 V$		1.5	2.5	3.5	V
I _{G(oc)}	open-circuit operating current	$V_{BG} = V_{LG} = 16 \text{ V}$		-	8.0	1.5	mA
` '	·	open load detected; other channel is off					

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Table 7: Static characteristics...continued

Limits are valid for $-40 \,^{\circ}\text{C} \le T_{mb} \le +150 \,^{\circ}\text{C}$ and typical values for $T_{mb} = 25 \,^{\circ}\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{L(oc)}	load open circuit current	V _{LG} = 3.5 V; per channel		-	-22	-40	μΑ
		V _{LG} = 16 V; per channel		-	-200	-300	μΑ
R _{L(oc)}	open circuit load resistor	V _S = 5 V; connected externally; per channel; Figure 10		-	10	-	kΩ
Undervolta	nge ^[9]						
V _{BG(uv)}	battery-ground undervoltage		[11]	2	4.2	5.3	V
$V_{BG(uv)(hys)}$	battery-ground undervoltage hysteresis			-	0.5	1.5	V
Overvoltag	je ^[9]						
$V_{BG(ov)}$	battery-ground overvoltage		[12]	35	40	45	V
V _{BG(ov)(hys)}	battery-ground overvoltage hysteresis			0.2	1	2	V
$I_{G(ov)}$	overvoltage operating current	V _{BG} = 45 V; per channel		-	1	2.5	mΑ
Overload p	protection						
I _{L(lim)}	self-limiting load current	$V_{BG} \ge 8 \text{ V}; V_{BL} = V_{BG}; Figure 7$		8	12	16	Α
Overtempe	erature protection ^{[9][10]}						
$T_{j(th)}$	threshold junction temperature		[13]	150	170	190	°C
$T_{j(th)(hys)}$	threshold junction temperature hysteresis			3	10	20	°C
Status [9]							
V _{SG(CL)}	status-ground clamping voltage	I _S = 100 μA		5.5	7	8.5	V
$V_{SG(L)}$	status-ground low voltage	I _S = 100 μA; Figure 6		-	0.7	0.9	V
		I _S = 250 μA		-	-	1.1	V
I _{S(off)}	status leakage current	V _{SG} = 5 V					
		T _{mb} = 150 °C		-	-	10	μΑ
		T _{mb} = 25 °C		-	0.1	0.1 1	μΑ
R _S	status resistor	V _{SG} = 5 V; connected externally; Figure 10	[14]	-	47	-	kΩ

^[1] For a high-side switch, the load pin voltage goes negative with respect to the ground during the turn-off of an inductive load. This negative voltage is clamped by the device.

- [3] This is the current drawn from the supply when both inputs are LOW, and includes leakage current to the loads.
- [4] Defined as in ISO10483-1. For comparison purposes only.
- [5] This only applies to the R_{BLon} per channel. The supply and input voltages for the R_{BLon} tests are continuous. The specified pulse duration is $t_p = 300 \,\mu s$, and refers only to the applied load current.
- [6] R_G is a resistor incorporated internally into the package.
- [7] $5.5 \text{ V} \le \text{V}_{BG} \le 35 \text{ V}$
- [8] An open circuit load can be detected in the off-state and requires an external pull-up resistor, R_{L(oc)}.
- [9] See Table 4 "Truth table"
- [10] Overtemperature protection is not active during reverse current operation.
- [11] Undervoltage sensor causes each output channel to switch off and reset.
- [12] Overvoltage sensor causes each output channel to switch off to protect the load.
- [13] After cooling below the reset temperature the channel will resume normal operation.
- [14] The status output is an open drain transistor and requires an external pull-up resistor, R_S, to indicate a logic HIGH.

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^[2] $9 \text{ V} \le \text{V}_{BG} \le 35 \text{ V}$

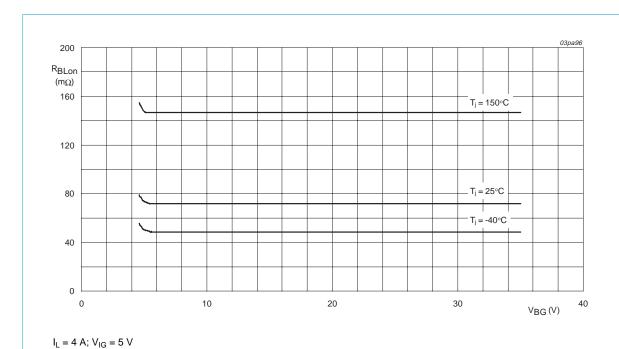


Fig 4. Battery-load on-state resistance as a function of battery-ground voltage; typical values.

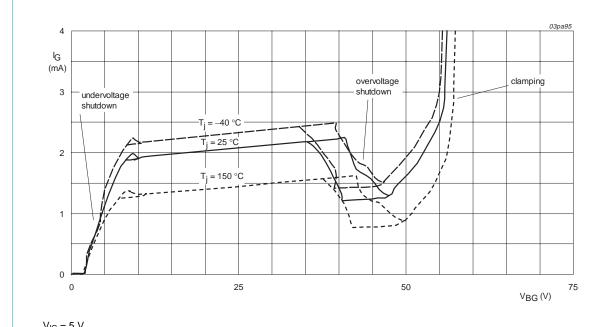
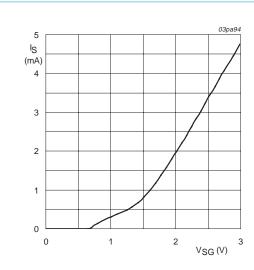


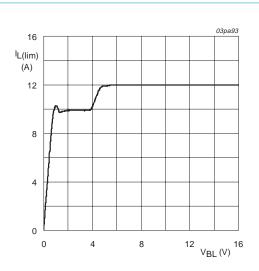
Fig 5. Supply current characteristics: operating current as a function of battery-ground voltage for one channel only; typical values.

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 V_{BG} = 13 V; V_{IG} = 5 V; T_i = 25 °C

Fig 6. Status current as a function of status-ground voltage; typical values.



 V_{BG} = 16 V; V_{IG} = 5 V; T_{mb} = 25 °C

Fig 7. Self-limiting load current as a function of battery-load voltage; typical values.

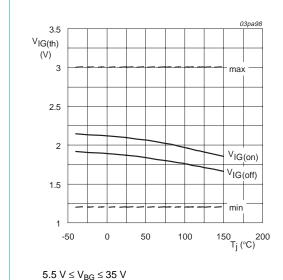
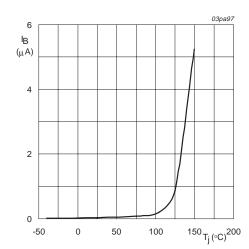


Fig 8. Input-ground threshold voltage as a function of junction temperature.



 $V_{BG} = 35 \text{ V}$

Fig 9. Battery quiescent current as a function of junction temperature; typical values.

Dynamic characteristics

Switching characteristics

 T_{mb} = 25 °C; V_{BG} = 13 V; resistive load R_L = 13 Ω per channel; Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Turn-on m	easured from the input going HIGH					
t _{d(on)}	turn-on delay time	to 10 % V _L	-	30	-	μs
dV/dt_{on}	rising slew rate	30 to 70 % V _L	0.5	1	2	V/μs
t _{on}	turn-on switching time	to 90 % V _L	-	60	220	μs
Turn-off m	neasured from the input going LOW					
$t_{d(off)}$	turn-off delay time	to 90 % V _L	-	20	-	μs
dV/dt_{off}	falling slew rate	70 to 30 % V _L	0.5	1	2	V/μs
t_{off}	turn-off switching time	to 10 % V _L	-	40	200	μs

Table 9: Capacitances

 $T_{mb}=25\,^{\circ}C;\,f=1\,MHz;\,V_{IG}=0\,V.$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
C_{sg}	status-ground capacitance	$V_{SG} = 5 V$	-	11	15	pF			
Per channel									
C _{ig}	input-ground capacitance	V _{BG} = 13 V	-	15	20	pF			
C _{bl}	battery-load capacitance	V _{BL} = 13 V	-	130	180	pF			

Table 10: Short circuit load protection characteristics

 $T_{mb} \le 125 \,^{\circ}C$ prior to the overload short circuit condition.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
P _{BL(OV)(th)}	battery-load overload power threshold			10	55	100	W
$t_{BL(d)(sc)}$	battery-load short-circuit characteristic time	$P_{BL} > P_{BL(OV)(th)}$; Figure 11	[1]	200	350	800	μs

[1] Short circuit response time $t_{d(sc)}$ varies with battery-load power P_{BL} according to the **logarithmic model** equation:

$$t_{d(sc)} \approx \frac{t_{BL(d)(sc)}}{ln(\frac{P_{BL}}{P_{BL(OV)(th)}})}$$

Table 11: Status response times

Limits are valid for $-40 \,^{\circ}\text{C} \le T_{mb} \le +150 \,^{\circ}\text{C}$ and typical values for $T_{mb} = 25 \,^{\circ}\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Measured from when the input goes LOW to when the status goes LOW						
$t_{d(oc)}$	open-circuit response time	Figure 10 and 14	-	65	100	μs

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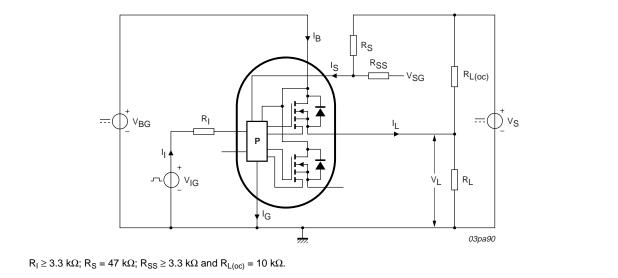
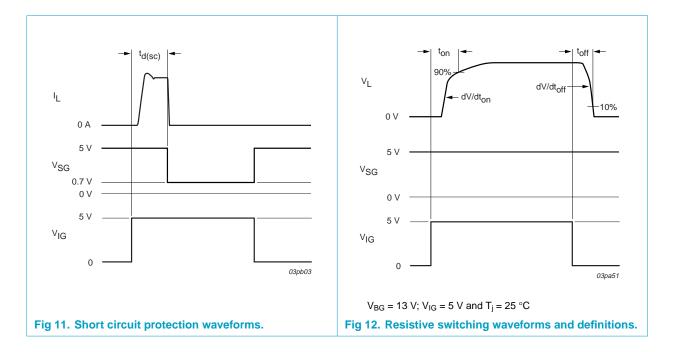
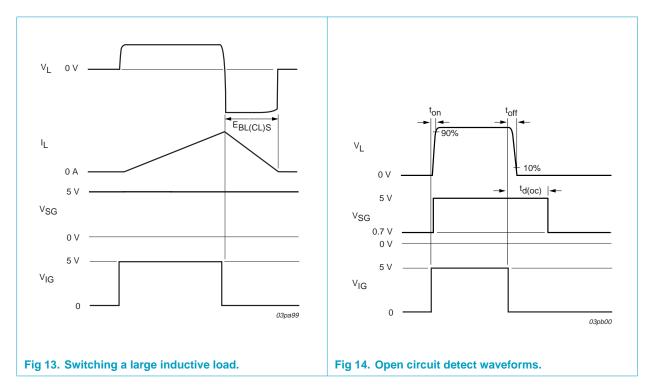


Fig 10. Typical dynamic response circuit diagram including reverse supply protection and open load detection.





10. Package information for SOT427

Epoxy meets requirements of UL 94 V-0 at 1/8 inch thickness. Net mass: 1.5 g. For soldering guidelines and surface mount footprint design, please visit http://www.semiconductors.philips.com/package/

11. Package outline

Plastic single-ended surface mounted package (Philips version of D²-PAK); 7 leads (one lead cropped)

SOT427

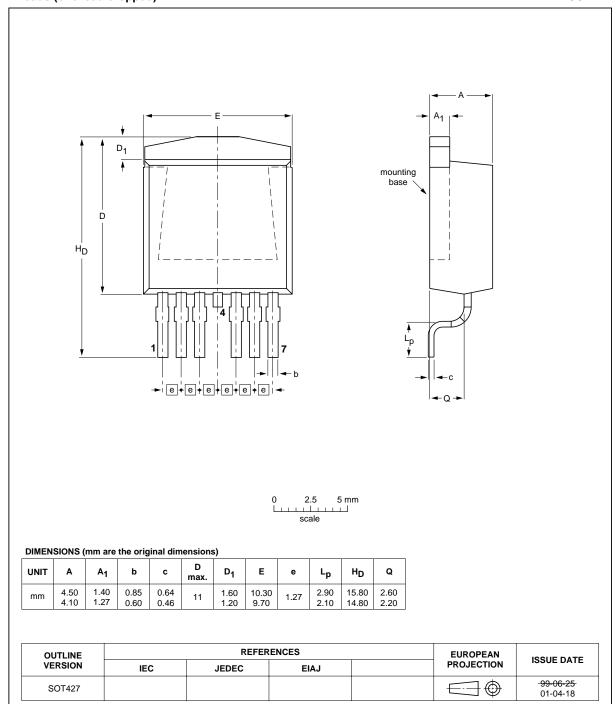


Fig 15. SOT427 (D²-PAK).

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PIP3221-DC

Dual channel high-side TOPFET™

12. Revision history

Table 12: Revision history

Rev	Date	CPCN	Description
01	20040220	-	Product data (9397 750 12361)

13. Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2][3]}	Definition
1	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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- For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

14. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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